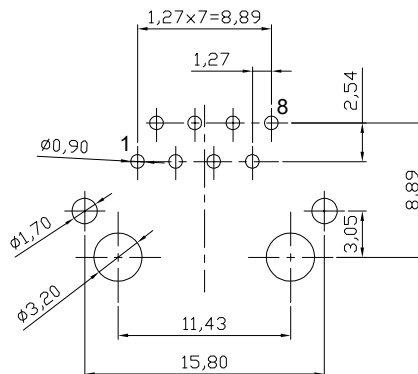


⑦ ③ DETAIL 'C'
SCALE 2:1





PC Board Layout
Component Side Shown

NOTES:

Mechanical:

1. Housing material : High Temp. Polyester UL94V-0 ,
Color: Black
 2. Contact material: Phosphor Bronze t=0.35mm
 - ③ 3. Contact plating: 6u" Gold on contact area
100u"~200u" Tin on solder area
all over 30u"~50u" Nickel
 - ④ 4. Shell material: Copper Alloy
 5. Shell plating: Nickel plated
 6. Operating Life: 750 Cycles min.
 7. PCB Retention Pre-solder: 1 LB min.
 8. PCB Retention Post-solder: 10 LBS min.
- Electrical:**
1. Voltage Rating: 125VAC.
 2. Current Rating: 1.5AMP.
 3. Contact Resistance: 45mΩ max.
 4. Insulation Resistance: 1000MΩ min. @ 500 VDC
 5. Dielectric Strength: 1000 VAC 60Hz, 1 min.
- Environmental:**
1. Storage: -40°C To +85°C
 2. Operation: -40°C~+85°C
 3. Wave Soldering Temperature: 255°C~265°C 5~10S

⑧ Packing: 80pcs/Tray,1920pcs/Carton

G	RoHS compliant Unit:mm  File No.: E345352	Scale	Free	⑧	Update the packing quantity	21.12.2021	Peter		Date	Name	Description. Modular Jack Pitch 1.27 8Pin	G	
		TOLERANCE		⑦	Correct PEG dimensions	16.05.2016	Amy	Drawn	07.11.2007	N.Schulz			
H		X.X	±0.20	⑥	Update the contact plating	25.08.2015	Amy	Approved	21.12.2021	Peter	ASSMANN WSW-No. A-20042-LP/FS	H	
		X.XX	±0.15	⑤	Modify the dimensions	18.12.2014	Amy						
		X.XXX	±0.10	④	Update	27.05.2013	Amy			Drawing-No.	ASS 0574 CO		rev08
		DIM	TOL	③	Modify notes Add dimensions	02.07.2009	Dean			Customer-No.			
		Angle	±5°	Id.	Modification	Date	Name				1 / 1		

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